

## Product Change Notice (PCN)

**Subject:** Assembly factory addition and assembly materials change for RL78/L1A, L1C LQFP package products

**Publication Date:** 1/21/2022

**Effective Date:** 4/1/2022

### Revision Description:

Initial release.

### Description of Change:

| PKG type |                | Products Group |     |
|----------|----------------|----------------|-----|
|          |                | L1A            | L1C |
| LFQFP    | 14x14mm 100pin | √              | √   |

Greatek Electronics Inc., (Greatek), King Yuan ELECTRONICS CO., LTD (KYECC) addition and T&R consolidation.

Renesas Semiconductor (Beijing) Co.,Ltd (RSB) lead frame and T&R consolidation.

“Note: Greatek/KYECC products are only full carton products and T&R products.”

“Refer to the difference specification for details.”

MCP-AB-22-0014\_RL78\_L1AL1C\_LQFP\_Difference specification1

MCP-AB-22-0015\_RL78\_L1AL1C\_LQFP\_Difference specification2\_LF

MCP-AB-21-0086\_RL78\_L1AL1C\_LQFP\_Difference specification3\_TR

### Description of change point case

| Before change |      |     | After change |                          |                        |
|---------------|------|-----|--------------|--------------------------|------------------------|
| WP&WT         | ASSY | FT  | WP&WT        | ASSY                     | FT                     |
| Kawashiri     | RSB  | RSB | Kawashiri    | RSB**<br><b>Greatek*</b> | RSB**<br><b>KYECC*</b> |

Note: Description for change point.

“Bold: Factory addition”

\*: Some products add Greatek/KYECC and some do not.

\*\*: Consolidate the lead frame and T&R.

### Affected Product List:

Refer to attached file “PN\_list\_RL78 \_L1AL1C\_LQFP”.

### Reason for Change:

Stable supply for RL78 series LQFP products.

**Impact on specifications, characteristics, quality & reliability:**

No impact.

**Product Identification:**

Possible to confirm the production history data from the packing label or trace code.

**Qualification Status:** We will prepare by 2/28/2022.

**Sample Availability Date:** 4/1/2022

**Device Material Declaration:** Contact Renesas sales, distributor, or agency.

## Note:

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[illegible]

# Difference of specification 1 (RL78 family LQFP products) 14x14mm 0.5mm pitch 100pin

Target products: RL78/L1A, RL78/L1C

January 11. 2022

MCU PRODUCT MARKETING DEPARTMENT  
MCU DEVICE SOLUTION BUSINESS DIVISION  
IoT AND INFRASTRUCTURE BUSINESS UNIT  
RENESAS ELECTRONICS CO., LTD.

Ver.1.0

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MCP-AB-22-0014

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(Rev. 5.0-1 October 2020)

# DIFFERENCE OUTLINE

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## 1. Targets:

Products : RL78/L1A, RL78/L1C  
Assembly factory : Renesas Semiconductor (Beijing) Co.,Ltd (RSB)  
Sorting factory : Renesas Semiconductor (Beijing) Co.,Ltd (RSB)  
Package : 14x14mm 0.5mm pitch 100pin LFQFP

## 2. Additional assembly and sorting factory

Assembly factory : Greatek Electronics Inc. (Greatek)  
Sorting factory : King Yuan ELECTRONICS CO., LTD (KYEC)

## 3. Assembly material:

Lead frame, Die mount paste and Mold resin are used certificated materials.

## 4. Package outline

There is no change in footprint for additional factory products.

Please refer to the package outline drawing and dimension comparison for the external dimensions.

# DIFFERENCE OUTLINE

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5. Storage conditions after opening the moisture proof packaging:

The storage conditions for Greatek products after opening the moisture-proof bag comply with JEDEC standards.

Existing products(RSB) : 30°C/70%RH/ within 168hr

Additional products(Greatek/KYEC) : 30°C/60%RH/ within 168hr (Confirming to the JEDEC standard)

■ Specification and characteristics of product:

No change

■ Quality and reliability:

No change

# Difference of specification

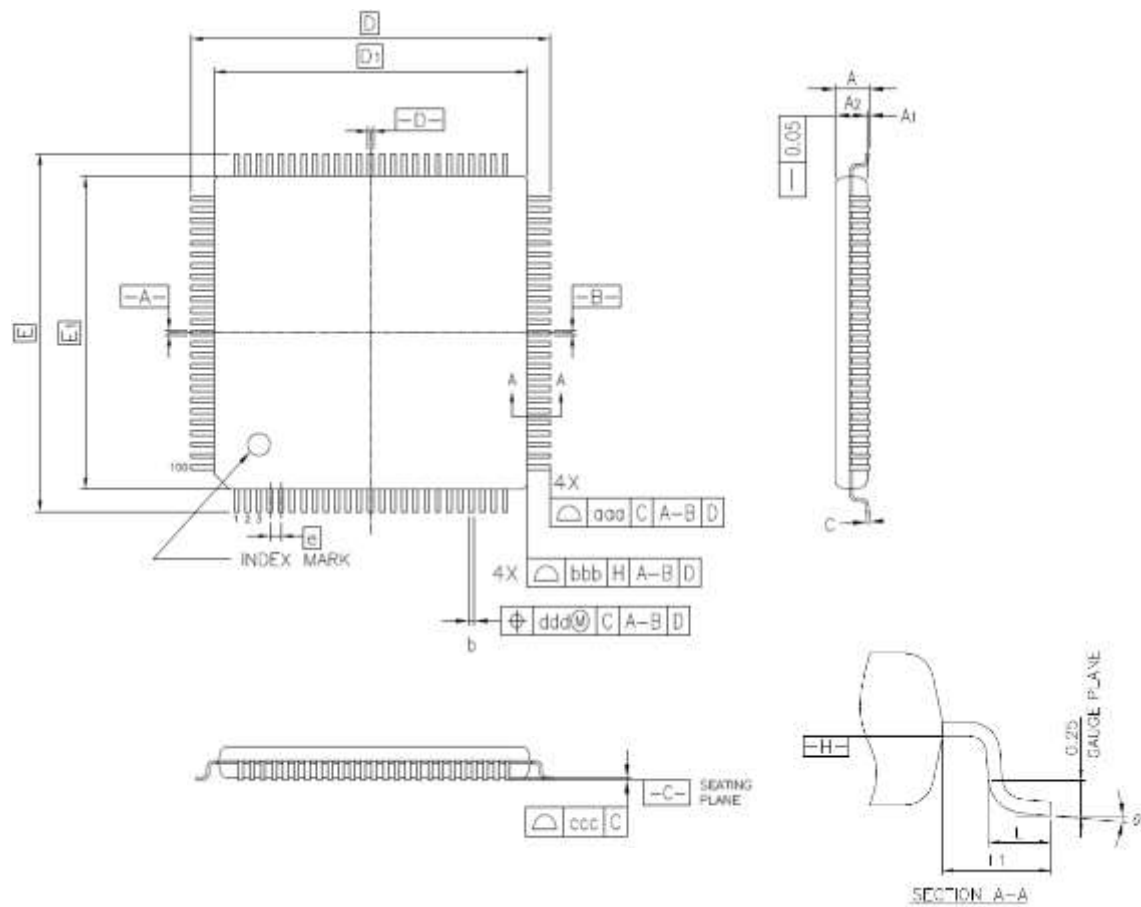
| Item               |                   | Additional factory                           | Existing factory               |
|--------------------|-------------------|----------------------------------------------|--------------------------------|
| Assembly factory   |                   | Greatek                                      | RSB                            |
| Sorting factory    |                   | KYEC                                         | RSB                            |
| Package            | Outline           | There are differences(Refer to pages 6 to 8) |                                |
| Lead frame         | Material          | No difference                                |                                |
|                    | Inner pattern     | There are differences(Refer to page 9)       |                                |
| Die mount          | Material          | Ag epoxy paste D *                           | Ag epoxy paste A *             |
| Bonding wire       | Material          | No difference; Cu (Pd coating)               |                                |
| Resin              | Material          | Epoxy resin D * (halogen-free)               | Epoxy resin A * (halogen-free) |
| Plating            | Material          | No difference                                |                                |
| Marking            | Font              | There are differences(Refer to page 10)      |                                |
|                    | Digit number      | No difference                                |                                |
| Packing            | Tray/ Emboss tape | No difference                                |                                |
| Storage conditions | after opening     | 30°C/60%RH/ within168hr                      | 30°C/70%RH/ within 168hr       |

\* Factory certified materials.

There are differences in materials, but there is no change in reliability or characteristics.

# 14mm x 14mm 0.5mm pitch 100pin LFQFP Package outline (Greatek)

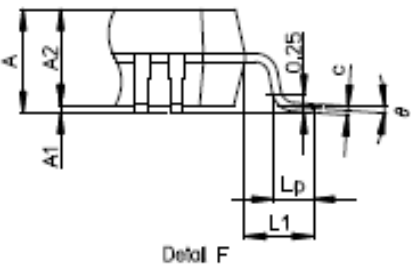
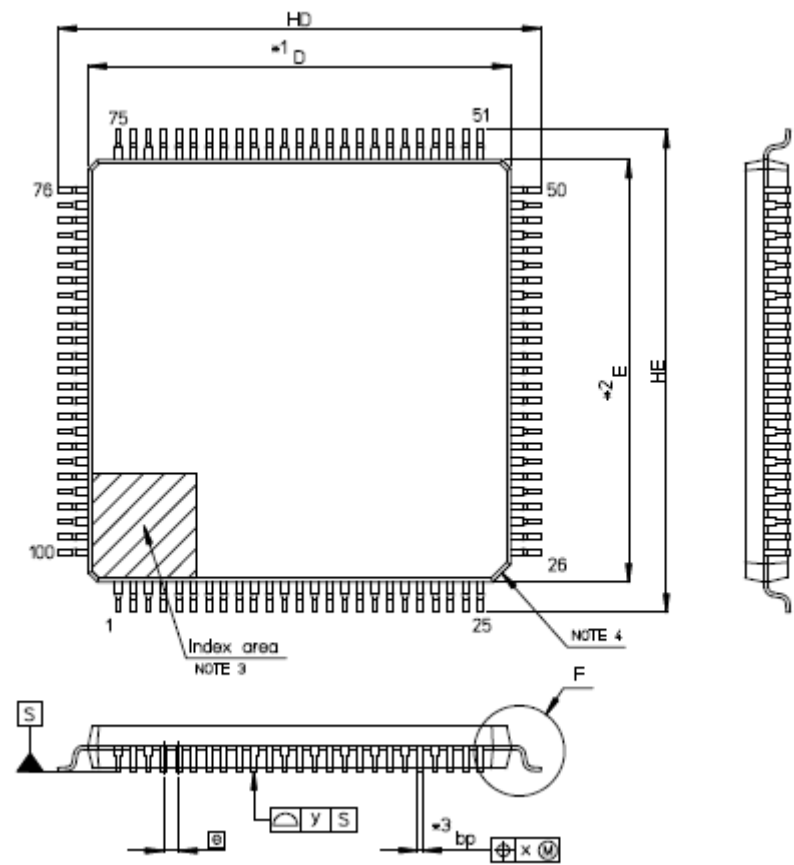
RENESAS Code : PLQP0100KP-A



| Reference<br>Symbol | Dimension in Millimeters |       |      |
|---------------------|--------------------------|-------|------|
|                     | Min.                     | Nom.  | Max. |
| A                   | —                        | —     | 1.60 |
| A <sub>1</sub>      | 0.05                     | —     | 0.15 |
| A <sub>2</sub>      | 1.35                     | 1.40  | 1.45 |
| D                   | —                        | 16.00 | —    |
| D <sub>1</sub>      | —                        | 14.00 | —    |
| E                   | —                        | 16.00 | —    |
| E <sub>1</sub>      | —                        | 14.00 | —    |
| N                   | —                        | 100   | —    |
| e                   | —                        | 0.50  | —    |
| b                   | 0.17                     | 0.22  | 0.27 |
| c                   | 0.09                     | —     | 0.20 |
| θ                   | 0°                       | 3.5°  | 7°   |
| L                   | 0.45                     | 0.60  | 0.75 |
| L <sub>1</sub>      | —                        | 1.00  | —    |
| aaa                 | —                        | —     | 0.20 |
| bbb                 | —                        | —     | 0.20 |
| ccc                 | —                        | —     | 0.08 |
| ddd                 | —                        | —     | 0.08 |

# 14mm x 14mm 0.5mm pitch 100pin LFQFP Package outline (RSB)

RENESAS Code : PLQP0100KB-B



| Reference<br>Symbol | Dimension in Millimeters |      |      |
|---------------------|--------------------------|------|------|
|                     | Min                      | Nom  | Max  |
| D                   | 13.9                     | 14.0 | 14.1 |
| E                   | 13.9                     | 14.0 | 14.1 |
| A2                  | —                        | 1.4  | —    |
| HD                  | 15.8                     | 16.0 | 16.2 |
| HE                  | 15.8                     | 16.0 | 16.2 |
| A                   | —                        | —    | 1.7  |
| A1                  | 0.05                     | —    | 0.15 |
| bp                  | 0.15                     | 0.20 | 0.27 |
| c                   | 0.09                     | —    | 0.20 |
| e                   | 0*                       | 3.5* | 8*   |
| e                   | —                        | 0.5  | —    |
| x                   | —                        | —    | 0.08 |
| y                   | —                        | —    | 0.08 |
| Lp                  | 0.45                     | 0.6  | 0.75 |
| L1                  | —                        | 1.0  | —    |

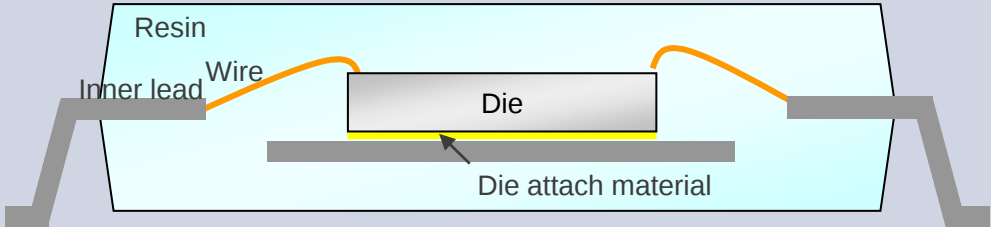
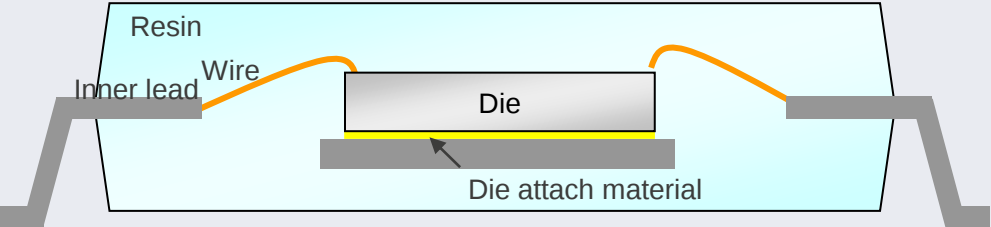
# Dimension comparison: 14mm x 14mm 0.5mm pitch 100pin LFQFP

Greatek package symbols complied JEDEC standard.

| Greatek<br>Symbol | 14x14mm 100pin LQFP<br>PLQP0100KP-A |       |      | RSB<br>Symbol | 14x14mm 100pin LQFP<br>PLQP0100KB-B |       |       |
|-------------------|-------------------------------------|-------|------|---------------|-------------------------------------|-------|-------|
|                   | Dimension in Millimeters            |       |      |               | Dimension in Millimeters            |       |       |
|                   | Min                                 | Nom   | Max  |               | Min                                 | Nom   | Max   |
| A                 | -                                   | -     | 1.60 | A             | -                                   | -     | 1.70  |
| A1                | 0.05                                | -     | 0.15 | A1            | 0.05                                | -     | 0.15  |
| A2                | 1.35                                | 1.40  | 1.45 | A2            | -                                   | 1.40  | -     |
| D                 | -                                   | 16.00 | -    | HD            | 15.80                               | 16.00 | 16.20 |
| D1                | -                                   | 14.00 | -    | D             | 13.90                               | 14.00 | 14.10 |
| E                 | -                                   | 16.00 | -    | HE            | 15.80                               | 16.00 | 16.20 |
| E1                | -                                   | 14.00 | -    | E             | 13.90                               | 14.00 | 14.10 |
| N                 | -                                   | 100   | -    | -             | -                                   | -     | -     |
| e                 | -                                   | 0.50  | -    | e             | -                                   | 0.50  | -     |
| b                 | 0.17                                | 0.22  | 0.27 | bp            | 0.15                                | 0.20  | 0.27  |
| c                 | 0.09                                | -     | 0.20 | c             | 0.09                                | -     | 0.20  |
| θ                 | 0°                                  | 3.5°  | 7°   | θ             | 0°                                  | 3.5°  | 8°    |
| L                 | 0.45                                | 0.60  | 0.75 | Lp            | 0.45                                | 0.60  | 0.75  |
| L1                | -                                   | 1.00  | -    | L1            | -                                   | 1.000 | -     |
| aaa               | -                                   | -     | 0.20 | -             | -                                   | -     | -     |
| bbb               | -                                   | -     | 0.20 | -             | -                                   | -     | -     |
| ccc               | -                                   | -     | 0.08 | y             | -                                   | -     | 0.08  |
| ddd               | -                                   | -     | 0.08 | x             | -                                   | -     | 0.08  |

# Package structure image

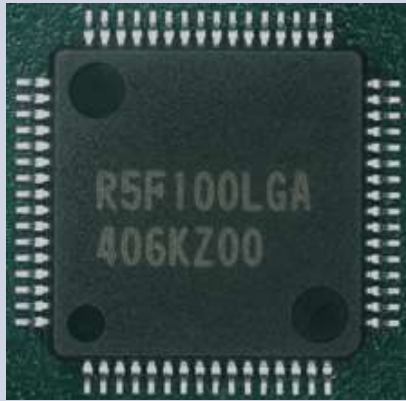
\* Package Section and die pad shape is a reference example.

| Assembly Line      | PKG cross section                                                                   | Die pad shape                                                                                  |
|--------------------|-------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------|
| Additional factory |   | <br>Greatek |
| Existing factory   |  | <br>RSB    |

✂ There is no impact on the reliability by die pad shape

# Marking visibility

※Character is reference example

| Assembly Line  | Greatek<br>(Additional factory)                                                     | RSB<br>(Existing factory)                                                            |
|----------------|-------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------|
| Overall photo  |   |   |
| Enlarged photo |  |  |

# 4M changing points

## (Addition of assembly and sorting factory , Change of material)

| Item            | Check Result                                                                                                                                                                                                           | Judgement      |
|-----------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------|
| <b>Machine</b>  | Changing at assembly and sorting. The machines are equivalent to present machines.<br><br>There are production of similar products and we have already checked the additional products have no risk on the production. | <b>No risk</b> |
| <b>Method</b>   | The same as current products.                                                                                                                                                                                          | <b>No risk</b> |
| <b>Man</b>      | Using operator certification system. Only certificated operator can work for the production.                                                                                                                           | <b>No risk</b> |
| <b>Material</b> | Only use certificated materials.<br>The products has been certificated by reliability test same as existing products and have no risk.                                                                                 | <b>No risk</b> |

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# Difference of specification 2 (RL78 family LQFP products) 14x14mm 0.5mm pitch 100pin

**Target products: RL78/L1A, RL78/L1C**

January 11. 2022

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(Rev. 5.0-1 October 2020)

# Difference outline

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## 1. Targets:

Products : RL78/L1A, RL78/L1C  
Assembly factory : Renesas Semiconductor (Beijing) Co.,Ltd (RSB)  
Sorting factory : Renesas Semiconductor (Beijing) Co.,Ltd (RSB)  
Package : 14x14mm 0.5mm pitch 100pin LFQFP

## 2. Difference point

Assembly material consolidation: Lead frame (Stabilize supply through consolidation)

- Specification and characteristics of product:  
No change
- Quality and reliability  
No change

# Difference of specification

| Item                    |               | After consolidated                      | Current |
|-------------------------|---------------|-----------------------------------------|---------|
| Target assembly factory |               | RSB                                     |         |
| Target sorting factory  |               | RSB                                     |         |
| Package                 | Outline       | No difference                           |         |
| Lead frame              | Material      | No difference                           |         |
|                         | Inner pattern | There are differences (Refer to page 5) |         |
| Die mount               | Material      | No difference                           |         |
| Bonding wire            | Material      | No difference                           |         |
| Resin                   | Material      | No difference                           |         |
| Plating                 | Material      | No difference                           |         |
| Marking                 | Font          | No difference                           |         |
|                         | Digit number  | No difference                           |         |

# 14×14mm 0.5mm pitch 100pin LFQFP lead frame

Consolidate into certified and proven lead frames.

## Frame A

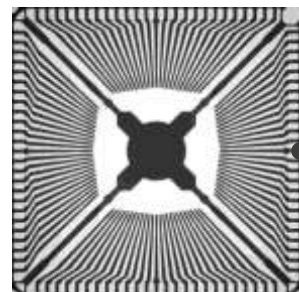
RL78/G13

RL78/G14 other than the following

RL78/I1B

RL78/L1A

RL78/L1C



## Frame B

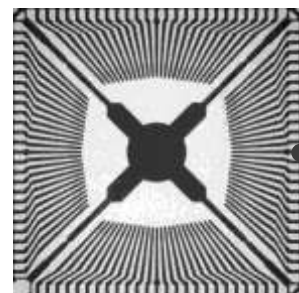
RL78/G13A

RL78/G14 :

R5F104PK\*\*FB

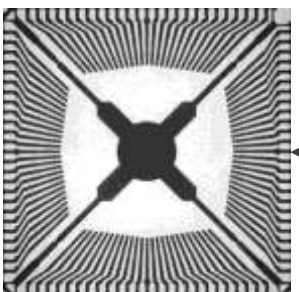
R5F104PL\*\*FB

RL78/I1C



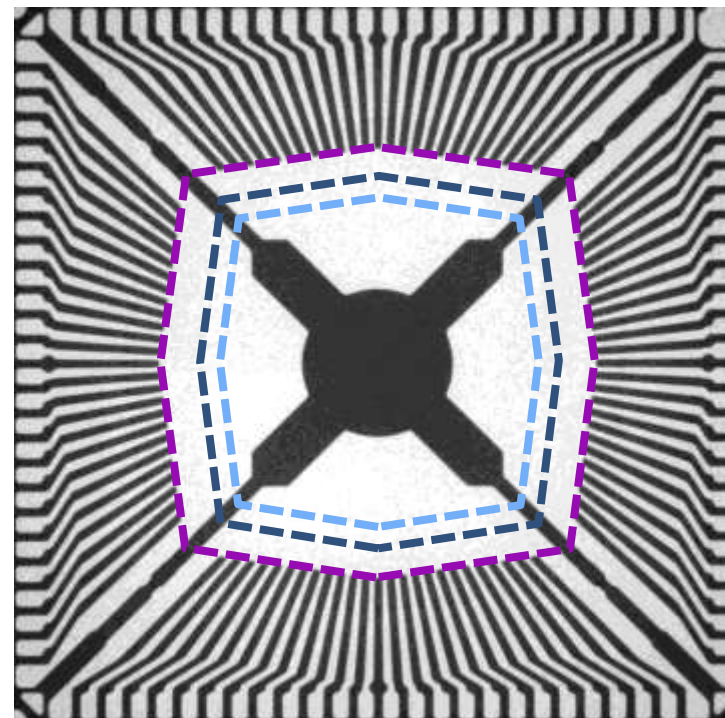
## Frame C

Used in other product groups  
such as RX family



Consolidated

After consolidated “Frame C”



 : Frame A

 : Frame C

 : Frame B

# Efforts for changing lead frames

The change points are verified and there is no problem.

| Change point      | Failure mode          | Cause                     | Response at startup                                                                  | Judgement  |
|-------------------|-----------------------|---------------------------|--------------------------------------------------------------------------------------|------------|
| Lead frame change | Assembly failure      | Positional deviation      | Mass productivity has been evaluated for similar products with the same PKG outline. | No problem |
|                   | Impact on reliability | Delamination after reflow | Mass productivity has been evaluated for similar products with the same PKG outline. | No problem |

# 4M change points (Assembly material change)

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| Item            | Check Result                                                                                                                           | Judgement      |
|-----------------|----------------------------------------------------------------------------------------------------------------------------------------|----------------|
| <b>Machine</b>  | The same as existing products.                                                                                                         | <b>No risk</b> |
| <b>Method</b>   | The same as existing products.                                                                                                         | <b>No risk</b> |
| <b>Operator</b> | Adopt operator certification system. Only certificated operator can work for the production.                                           | <b>No risk</b> |
| <b>Material</b> | Only use certificated materials.<br>The products has been certificated by reliability test same as existing products and have no risk. | <b>No risk</b> |

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# Difference of specification 3 (RL78 family LQFP products) 14x14mm 0.5mm pitch 100pin

**Target products: RL78/L1A, RL78/L1C**

January 11. 2022

MCU PRODUCT MARKETING DEPARTMENT  
MCU DEVICE SOLUTION BUSINESS DIVISION  
IoT AND INFRASTRUCTURE BUSINESS UNIT  
RENESAS ELECTRONICS CO., LTD.

Ver.1.0

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MCP-AB-21-0086

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# Difference outline

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- Target products:  
RL78/L1A, RL78/L1C
  - Assembly factory  
Renesas Semiconductor (Beijing) Co.,Ltd (RSB)  
Greatek Electronics Inc. (Greatek)
  - Sorting factory  
Renesas Semiconductor (Beijing) Co.,Ltd (RSB)  
King Yuan Electronics Co., Ltd. (KYTEC)
  - Target package  
14x14mm 0.5mm pitch 100pin LFQFP
  - Difference point  
Packing material: We will change the embossed carrier tape width from 32mm width to 24mm width and consolidate it into the 24mm width packaging form.
- 
- Specification and characteristics of product:  
No change
  - Quality and reliability  
No change

# Difference outline

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## 1. Targets:

Products : RL78/L1A, RL78/L1C  
Assembly factory : Renesas Semiconductor (Beijing) Co.,Ltd (RSB)  
Greatek Electronics Inc. (Greatek)  
Sorting factory : Renesas Semiconductor (Beijing) Co.,Ltd (RSB)  
King Yuan Electronics Co., Ltd. (KYEC)  
Package : 14x14mm 0.5mm pitch 100pin LFQFP

## 2. Difference point

Packing material : Change the emboss carrier tape width from 32mm width to 24mm width and consolidate to the 24mm width packing form.

- Specification and characteristics of product:  
No change
- Quality and reliability  
No change

# DIFFERENCES IN PACKING SPECIFICATIONS

| Material     | Item                  | New                     | Current           |
|--------------|-----------------------|-------------------------|-------------------|
| Carrier tape | Tape name             | E2424Q14RA              | MTE3224H-100P6Q-A |
|              | Feed hole             | <b>Single side hole</b> | Both sides hole   |
|              | Tape width            | <b>24mm</b>             | 32mm              |
|              | Tape thickness        | 0.3mm                   | 0.3mm             |
|              | Pocket size           | <b>16.5x16.5</b>        | 17.3x17.3         |
|              | Pitch between pockets | 24mm                    | 24mm              |
|              | Material              | PS                      | PS                |
| Reel         | Reel diameter         | 330mm                   | 330mm             |
|              | Core diameter         | 100mm                   | 100mm             |
|              | Reel width            | <b>24mm</b>             | 32mm              |
| Cover tape   | Tape width            | <b>21.3mm</b>           | 25.5mm            |

\* RL78/L1A and RL78/L1C 14x14mm 100pin products are target products.  
Other RL78 14x14mm products are using the carrier tape after consolidation.



## 4M changing points (Packing material change)

| Item     | Check Result                                                                                                                           | Judgement |
|----------|----------------------------------------------------------------------------------------------------------------------------------------|-----------|
| Machine  | The same as existing products.                                                                                                         | No risk   |
| Method   | The same as existing products.                                                                                                         | No risk   |
| Operator | Adopt operator certification system. Only certificated operator can work for the production.                                           | No risk   |
| Material | Only use certificated materials.<br>The products has been certificated by reliability test same as existing products and have no risk. | No risk   |

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